# **Hyperfast Rectifier**

30 A, 600 V

## RHRG3060-F085

### Description

The RHRG3060-F085 is a hyperfast diode with soft recovery characteristics (trr < 45 ns). It has half the recovery time of ultrafast diode and is of silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as a freewheeling/clamping diode and rectifier in a variety of automotive switching power supplies and other power switching automotive applications. Its low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits, thus reducing power loss in the switching transistors.

#### **Features**

- High Speed Switching ( $t_{rr} = 45 \text{ ns(Typ.)} @ I_F = 30 \text{ A}$ )
- Low Forward Voltage ( $V_F = 1.64 \text{ V(Typ.)}$  @  $I_F = 30 \text{ A}$ )
- Avalanche Energy Rated
- AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free

### **Applications**

- Switching Power Supply
- Power Switching Circuits
- Automotive and General Purpose

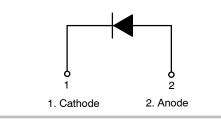


### ON Semiconductor®

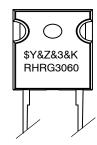
www.onsemi.com



TO-247-2LD CASE 340CL



### **MARKING DIAGRAM**



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code &3 = Numeric Date Code &K = Lot Code

RHRG3060 = Specific Device Code

### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

### ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C unless otherwise noted)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	600	٧
Working Peak Reverse Voltage	$V_{RWM}$	600	V
DC Blocking Voltage	V <sub>R</sub>	600	V
Average Rectified Forward Current (T <sub>C</sub> = 25°C)	I <sub>F(AV)</sub>	30	Α
Non-repetitive Peak Surge Current (Halfwave 1 Phase 50 Hz)	I <sub>FSM</sub>	90	Α
Avalanche Energy (1 A, 40 mH)	E <sub>AVL</sub>	20	mJ
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>STG</sub>	–55 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Tube	Quantity
RHRG3060-F085	RHRG3060	TO-247-2LD	-	30

### THERMAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{ heta JC}$	0.66	°C/W
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	45	°C/W

### **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions		Min	Тур	Max	Unit
Instantaneous Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 600 V	T <sub>C</sub> = 25°C	-	-	250	μΑ
			T <sub>C</sub> = 175°C	-	-	1.5	mA
Instantaneous Forward Voltage	V <sub>FM</sub>	I <sub>F</sub> = 30 A	T <sub>C</sub> = 25°C	-	1.64	2.1	V
(Note 1)			T <sub>C</sub> = 175°C	-	1.24	1.7	V
Reverse Recovery Time (Note 2)	t <sub>rr</sub>	$I_F = 1 \text{ A, di/dt} = 200 \text{ A/}\mu\text{s,}$ $V_{CC} = 390 \text{ V}$	T <sub>C</sub> = 25°C	-	24	40	ns
		I <sub>F</sub> = 30 A, di/dt = 200 A/μs,	T <sub>C</sub> = 25°C	-	33	45	ns
		V <sub>CC</sub> = 390 V	T <sub>C</sub> = 175°C	-	136	-	ns
Reverse Recovery Time	ta	I <sub>F</sub> = 30 A, di/dt = 200 A/μs,	T <sub>C</sub> = 25°C	-	19	-	ns
	t <sub>b</sub>	V <sub>CC</sub> = 390 V		-	14	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>			_	60	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

- 1. Pulse: Test Pulse Width = 300 μs, Duty Cycle = 2%
- 2. Guaranteed by design.

### TYPICAL PERFORMANCE CHARACTERISTICS

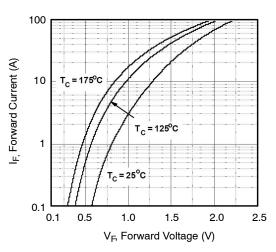


Figure 1. Typical Forward Voltage Drop vs. Forward Current

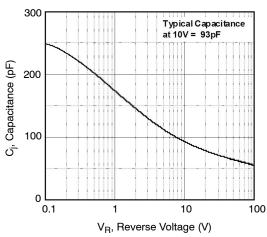


Figure 3. Typical Junction Capacitance

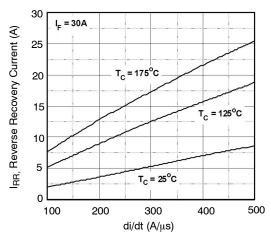


Figure 5. Typical Reverse Recovery Current vs. di/dt

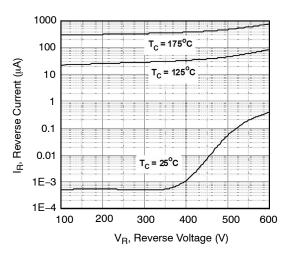


Figure 2. Typical Reverse Current vs. Reverse Voltage

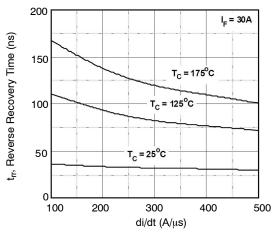


Figure 4. Typical Reverse Recovery Time vs. di/dt

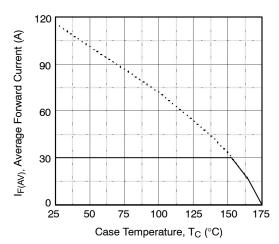


Figure 6. Forward Current Derating Curve

### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

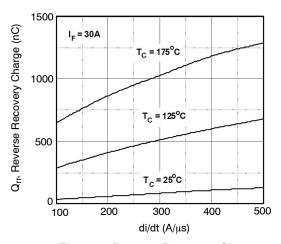


Figure 7. Reverse Recovery Charge

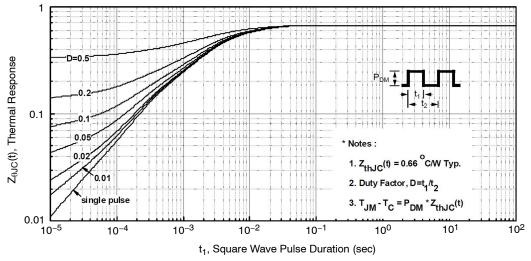
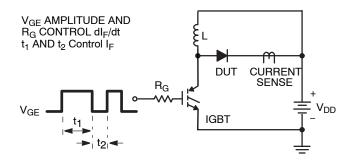


Figure 8. Transient Thermal Response Curve

### **TEST CIRCUIT AND WAVEFORMS**



 $0 \xrightarrow{\text{l}_{\text{F}}} \frac{\text{dl}_{\text{F}}}{\text{dt}} \xrightarrow{\text{t}_{\text{m}}} t_{\text{m}} \xrightarrow{\text{t}_{\text{b}}} 0.25 \, I_{\text{RM}}$ 

Figure 9. t<sub>rr</sub> Test Circuit

Figure 10. t<sub>rr</sub> Waveforms and Definitions

$$\begin{split} I &= 1 \text{ A} \\ L &= 40 \text{ mH} \\ R &< 0.1 \text{ }\Omega \\ E_{AVL} &= 1/2 LI^2 \left[ V_{R(AVL)}/(V_{R(AVL)} - V_{DD}) \right] \\ Q_1 &= IGBT \left( BV_{CES} > DUT V_{R(AVL)} \right) \end{split}$$

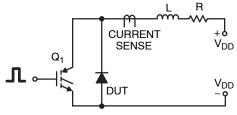


Figure 11. Avalanche Energy Test Circuit

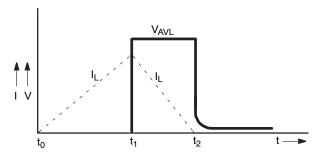
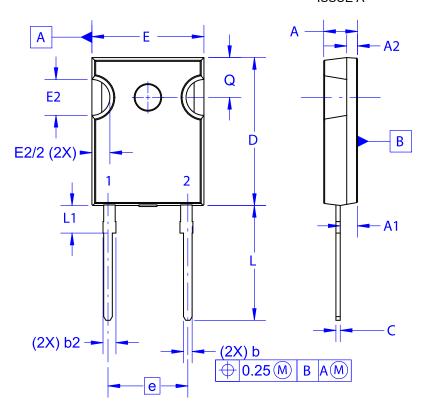


Figure 12. Avalanche Current and Voltage Waveforms

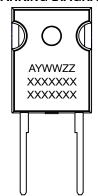
### TO-247-2LD CASE 340CL **ISSUE A**





- A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DRAWING CONFORMS TO ASME Y14.5 2009.
  D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
- E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

### **GENERIC MARKING DIAGRAM\***



XXXX = Specific Device Code

= Assembly Location

= Year

WW = Work Week

= Assembly Lot Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

	DATE 03 DEC 2019		
Ø P —		Ø P1 D2	
E1 —	1	D1	
,		9	

DIM	MIL	LIMETER	S
	MIN	NOM	MAX
Α	4.58	4.70	4.82
A1	2.29	2.40	2.66
A2	1.30	1.50	1.70
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
С	0.51	0.61	0.71
D	20.32	20.57	20.82
D1	16.37	16.57	16.77
D2	0.51	0.93	1.35
Е	15.37	15.62	15.87
E1	12.81	~	~
E2	4.96	5.08	5.20
е	~	11.12	~
L	15.75	16.00	16.25
L1	3.69	3.81	3.93
ØΡ	3.51	3.58	3.65
ØP1	6.61	6.73	6.85
Q	5.34	5.46	5.58
S	5.34	5.46	5.58

DOCUMENT NUMBER:	98AON13850G	Electronic versions are uncontrolled except when accessed directly from the Document Reposito Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	TO-247-2LD		PAGE 1 OF 1

ON Semiconductor and un are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

#### ADDITIONAL INFORMATION

**TECHNICAL PUBLICATIONS:** 

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$ 

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales